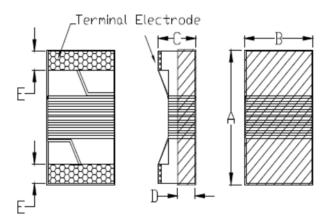


FEATRLRES

- Monolithic inorganic material construction.
- Closed magnetic circuit avoids crosstalk.
- S.M.T. type.
- Suitable for reflow soldering.
- Shapes and dimensions follow E.I.A. spec.
- Available in various sizes.
- Excellent solder ability and heat resistance.
- High reliability.
- 100% Lead(Pb) & Halogen-Free and RoHS compliant.

CONFIGRLRATIONS & DIMENSIONS (unit in mm)



Size	Α	В	С	D	E
SWF2012	2.4max	1.6max	1.4max	0.51ref.	0.44 ± 0.1

ELECTRICAL CHARACTERISTICS

Part Number	Inductance	Tolerance	Test Frequency	Q	Test Frequency	SRF	DCR(Ω)	Rated
i art Namber	(uH)	Torcranee	(Hz)	min.	(MHz)	(MHz) min.	max.	Current
SWF2012CF-R47K	0.47±10%	K,M	0.5V/7.96M	10	7.96	750	0.20	720
SWF2012CF-R56K	$0.56 \pm 10\%$	K,M	0.5V/7.96M	10	7.96	730	0.21	665
SWF2012CF-R68K	0.68±10%	K,M	0.5V/7.96M	10	7.96	670	0.28	565
SWF2012CF-R82K	0.82±10%	K,M	0.5V/7.96M	10	7.96	650	0.31	545
SWF2012CF-1R0K	1.00±10%	K,M	0.5V/7.96M	10	7.96	615	0.34	525
SWF2012CF-1R2K	1.20±10%	K,M	0.5V/7.96M	10	7.96	550	0.39	473
SWF2012CF-1R5K	1.50±10%	K,M	0.5V/7.96M	10	7.96	520	0.45	300
SWF2012CF-1R8K	1.80±10%	K,M	0.5V/7.96M	10	7.96	500	0.48	230
SWF2012CF-2R2K	2.20±10%	K,M	0.5V/7.96M	10	7.96	420	0.67	215
SWF2012CF-2R7K	2.70±10%	K,M	0.5V/7.96M	10	7.96	410	0.74	140
SWF2012CF-3R3K	$3.30 \pm 10\%$	K,M	0.5V/7.96M	10	7.96	385	0.81	9 5
SWF2012CF-3R9K	3.90±10%	K,M	0.5V/7.96M	10	7.96	372	0.88	57
SWF2012CF-4R7K	4.70±10%	K,M	0.5V/7.96M	10	7.96	345	0.99	51
SWF2012CF-5R6K	5.60±10%	K,M	0.5V/7.96M	10	7.96	335	1.06	44
SWF2012CF-6R8K	6.80±10%	K,M	0.5V/7.96M	10	7.96	315	1.21	39

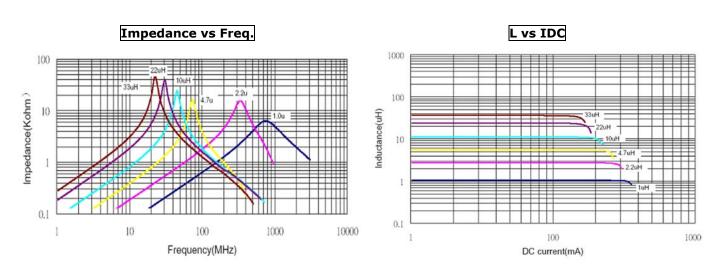
HSIA TECHNOLOGY CO.LTD. TEL:886-2-2999-6691 FAX: 2999-6692 Website:www.hsia.com.tw



SA-SP-001

SWF2012CF-8R2K	8.20±10%	K,M	0.5V/7.96M	10	7.96	295	1.33	33
SWF2012CF-100K	10.0±10%	K,M	0.5V/2.52M	10	2.52	260	1.79	30
SWF2012CF-120K	12.0±10%	K,M	0.5V/2.52M	10	2.52	250	1.98	27
SWF2012CF-150K	15.0±10%	K,M	0.5V/2.52M	10	2.52	215	2.68	22
SWF2012CF-180K	18.0±10%	K,M	0.5V/2.52M	10	2.52	195	3.12	20
SWF2012CF-220K	22.0±10%	K,M	0.5V/2.52M	10	2.52	180	3.48	18
SWF2012CF-270K	27.0±10%	K,M	0.5V/2.52M	10	2.52	170	3.84	16
SWF2012CF-330K	33.0±10%	K,M	0.5V/2.52M	10	2.52	145	4.34	15

- NOTE: K=±10%,L=±15%,M=±20%
- Rated current: based on temperature rise test
- In compliance with EIA 595



Impedance vs Frequency, DC Bias Characteristics (Typical)



Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125°C (Including self - temperature rise)	
Storage temperature	110~+40℃,50~60%RH (Product with taping) 240~+125℃ (on board)	
Electrical Performance Test		
Inductance	Refer to standard electrical characteristics list.	HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.
DCR		CH16502, Agilent 33420A Micro-Ohm Meter.
Saturation Current (Isat)	Approximately∆L30%	Saturation DC Current (Isat) will cause L0 to drop $\ \triangle L(\%)$
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise $\triangle T(^{\circ}C)$. 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer
Reliability Test		
Life Test		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature : 125±2°C (Inductor) Applied current : rated current Duration : 1000±12hrs Measured at room temperature after placing for 24±2 hrs Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC
Load Humidity		J-STD-020DClassification Reflow Profiles Humidity : $85\pm 2 \times R.H$, Temperature : $85^{\circ}C \pm 2^{\circ}C$ Duration : 1000hrs Min. with 100% rated current
Moisture Resistance	Appearance : No damage. Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	 Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles 1. Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 4. Keep at 25°C for 2 hrs then keep at -10°C for 3 hrs 4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.
Thermal shock Vibration		OldDClassification Reflow Profiles Condition for 1 cycle Step1 : -40±2°C 30±5min Step2 : 25±2°C ≤0.5min Step3 : 125±2°C 30±5min Number of cycles : 500 Measured at room temperature after placing for 24±2 hrs Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minutes Equipment : Vibration checker
		Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations).
Bending		Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.
Shock	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the expecification value.	TypePeak value (g's)Normal duration (D)Wave formVelocity change (Vi)ft/secSMD5011Half-sine11.3
	exceed the specification value	Lead 50 11 Half-sine 11.3
Solder ability	More than 95% of the terminal electrode should be covered with solder,	Preheat: 150℃,60sec.。 Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5℃ 。



		Flux for lead free: Rosin. 9.5% °
		Dip time: 4±1sec •
		Depth: completely cover the termination
		Depth: completely cover the termination
		Temperature Temperature(°C) Time(s) ramp/immersion Number of
Resistance to Soldering Heat		Temperature(°C) Time(s) ramp/immersion Number of and emersion rate heat cycles
rissistance to containing risat		
		260 ±5 10 ±1 25mm/s ±6 mm/s 1
		(solder temp)
		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-
		020DClassification Reflow Profiles
		With the component mounted on a PCB with the device to be tested,
		apply a force(>0805:1kg , <=0805:0.5kg)to the side of a device being
		tested. This force shall be applied for 60 +1 seconds. Also the force shall
	Appearance : No damage.	be applied gradually as not to apply a shock to the component being tested.
	Impedance : within±15% of initial value	
Terminal	Inductance : within±10% of initial value	
	Q : Shall not exceed the specification value.	DUT T
5	RDC : within ±15% of initial value and shall not	
	exceed the specification value e	wide
		thick
		substrate press tool

Note : When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition.